

AM83135-050

RF & MICROWAVE TRANSISTORS S-BAND RADAR APPLICATIONS

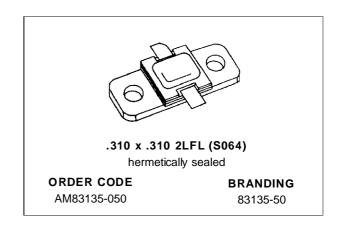
- REFRACTORY/GOLD METALLIZATION
- EMITTER SITE BALLASTED
- RUGGEDIZED VSWR 3:1 @ 1dB OVERDRIVE
- LOW THERMAL RESISTANCE
- INPUT/OUTPUT MATCHING
- OVERLAY GEOMETRY
- METAL/CERAMIC HERMETIC PACKAGE
- POUT = 50 W MIN. WITH 5.2 dB GAIN

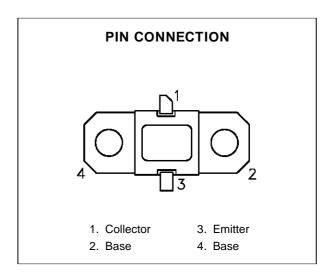
DESCRIPTION

The AM83135-050 device is a high power silicon bipolar NPN transistor specifically designed for S-Band radar pulsed output and driver applications.

This device is characterized at 10 μ sec pulsewidth and 10% duty cycle, but is capable of operation over a range of pulse widths, duty cycles and temperatures and can withstand a 3:1 output VSWR with a +1 dB input overdrive. Low RF thermal resistance, refractory/gold metallization, and computerized automatic wire bonding techniques ensure high reliability and product consistency (including phase characteristics).

The AM83135-050 is supplied in the IMPACTM Hermetic Metal/Ceramic package with internal Input/Output impedance matching circuitry, and is intended for military and other high reliability applications.





ABSOLUTE MAXIMUM RATINGS $(T_{case} = 25^{\circ}C)$

Symbol	Parameter	Value	Unit
P _{DISS}	Power Dissipation* (T _C ≤ 125°C)	312	W
Ic	Device Current*	8.0	A
Vcc	Collector-Supply Voltage*	48	V
TJ	Junction Temperature (Pulsed RF Operation)	250	°C
T _{STG}	Storage Temperature	- 65 to +200	°C

THERMAL DATA

R _{TH(j-c)} Junction-Case Thermal Resistance* 0.40 °C/W
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^{*}Applies only to rated RF amplifier operation

November 27, 1996

ELECTRICAL SPECIFICATIONS $(T_{case} = 25^{\circ}C)$

STATIC

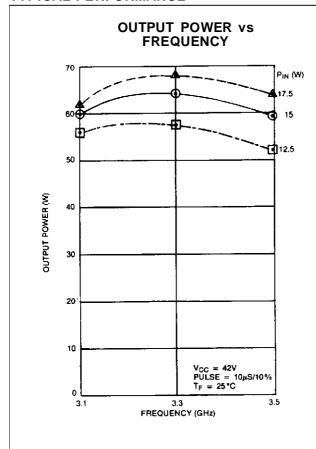
Cymbol	Test Conditions	Value			Unit		
Symbol	rest Conditions		Min.	Тур.	Max.	Offic	
BV _{CBO}	I _C = 25mA	$I_E = 0mA$		55			V
BV _{EBO}	I _E = 5mA	I _C = 0mA		3.5	_	_	V
BV _{CER}	I _C = 25mA	$R_{BE} = 10W$		55	_	_	V
ICES	V _{BE} = 0V	V _{CE} = 42V			_	20	mA
h _{FE}	V _{CE} = 5V	Ic = 3A		30	_	300	_

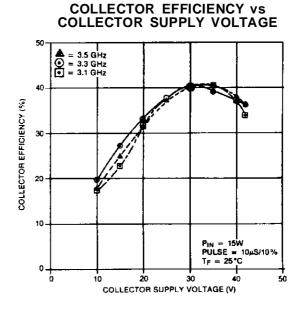
DYNAMIC

Symbol	Test Conditions		Value			Unit	
				Min.	Тур.	Max.	
Pout	f = 3.1 — 3.5GHz	$P_{IN} = 15W$	$V_{CC} = 42V$	50	_		W
ης	f = 3.1 — 3.5GHz	P _{IN} = 15W	V _C C = 42V	30	_	_	%
G _P	f = 3.1 — 3.5GHz	P _{IN} = 15W	V _{CC} = 42V	5.2	_	_	dB

Note: Pulse Width = 10μ Sec Duty Cycle = 10%

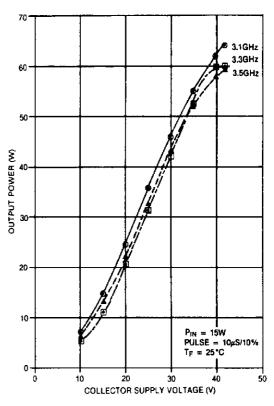
TYPICAL PERFORMANCE





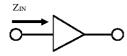
COLLECTOR EFFICIENCY vs FREQUENCY 10 Vcc = 42V PULSE = 10pS/10% T_F = 25°C 3.5 FREQUENCY (GHz)

OUTPUT POWER vs COLLECTOR SUPPLY VOLTAGE

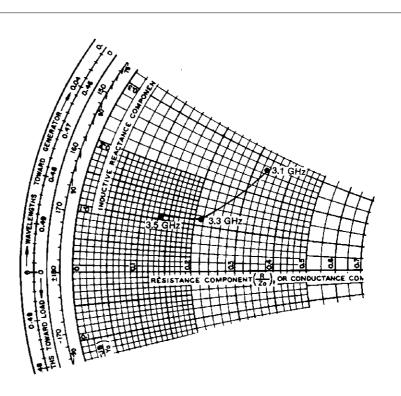


IMPEDANCE DATA

TYPICAL INPUT IMPEDANCE

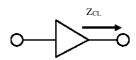


$$\begin{split} P_{IN} &= 15 \ W \\ V_{CC} &= 42 \ V \\ Z_{O}^{\star} &= 50 \ ohms \end{split}$$



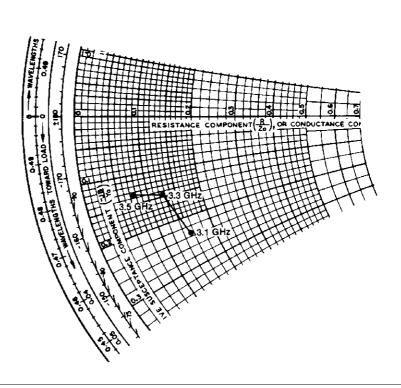
FREQ.	Z _{IN} (Ω)	Z _{CL} (Ω)		
L = 3.1 GHz	16.5 + j 13.5	7.7 – j 11.8		
M = 3.3 GHz	10.8 + j 5.5	6.5 – j 7.2		
H = 3.5 GHz	6.7 + j 5.2	3.8 – j 6.7		

TYPICAL COLLECTOR LOAD IMPEDANCE

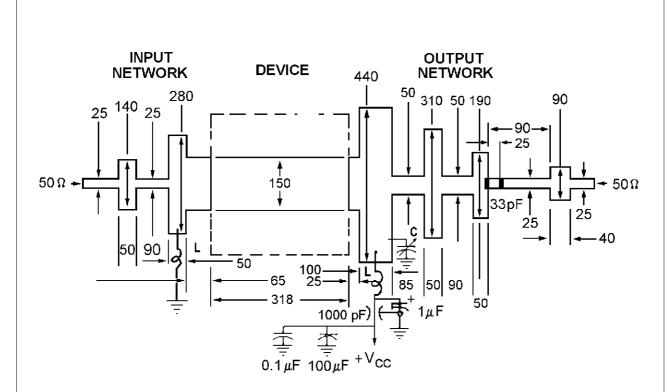


 $P_{IN} = 15 \text{ W}$ $V_{CC} = 42 \text{ V}$ $Z_{O}^* = 50 \text{ ohms}$

*Normalized



TEST CIRCUIT



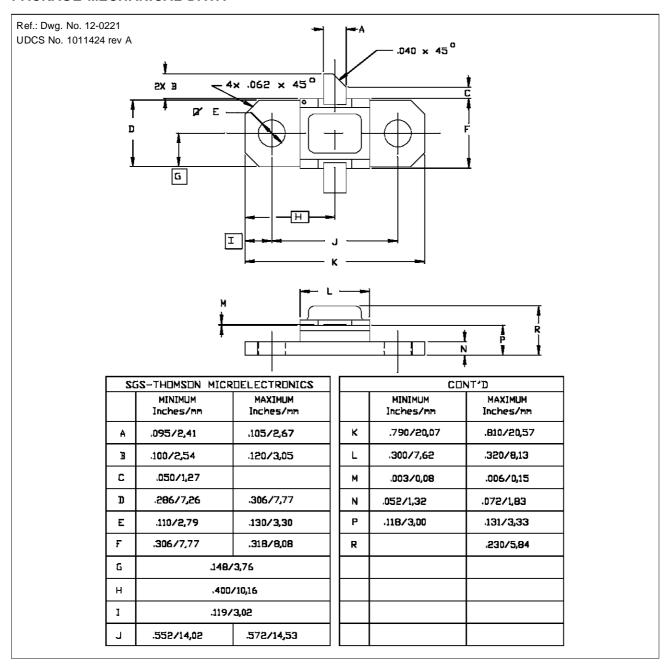
All dimensions are in mils.

Substrate material: 25 mil thick Al_2O_3 ($E_r = 9.6$)

C - 0.3 to 1.2 pF Johanson Gigatrim

L - 1 Turn #26 wire .80 I.D.

PACKAGE MECHANICAL DATA



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